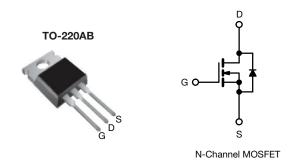
Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



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PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.109			
Q _g max. (nC)	47				
Q _{gs} (nC)	12				
Q _{gd} (nC)	11				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP125N60EF-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	V	
Gate-source voltage			V _{GS}	± 30	V	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	1	25		
	VGS at 10 V	T _C = 100 °C	I _D	16	A	
Pulsed drain current ^a			I _{DM}	66		
Linear derating factor				1.4 V		
Single pulse avalanche energy ^b			E _{AS}	88		
Maximum power dissipation			PD	179	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		al / alt	70		
Reverse diode dv/dt ^d		dv/dt	50	V/ns		
Soldering recommendations (peak temperature) ^c	For 10 s			260	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 2.5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, di/dt$ = 500 A/µs, starting T_J = 25 $^\circ C$



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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX. 62		UNIT		
Maximum junction-to-ambient	R _{thJA}	-				20.001		
Maximum junction-to-case (drain)	R _{thJC}	-	- 0.7			- °C/W		
	•	•						
SPECIFICATIONS (T _J = 25 °C, u	nless otherwi	se noted)						
PARAMETER	SYMBOL		T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static						1	1	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 µA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C	I _D = 1 mA	-	0.67	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	3.0	-	5.0	V
Osta asumas kaskana	_	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Gate-source leakage	I _{GSS}	Ň	$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zava anto voltago droin ourrent	I _{DSS}	V _{DS} = 480 V, V _{GS} = 0 V		-	-	1	μA	
Zero gate voltage drain current		$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	2	mA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	l _i	_D = 12 A	-	0.109	0.125	Ω
Forward transconductance ^a	g _{fs}	V _{DS}	= 20 V, I _D =	= 12 A	-	6	-	S
Dynamic								
Input capacitance	C _{iss}		V _{GS} = 0 V,		-	1533	-	
Output capacitance	C _{oss}	$V_{DS} = 100 V,$ f = 1 MHz		-	68	-	pF	
Reverse transfer capacitance	C _{rss}			-	6	-		
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	54	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	351	-		
Total gate charge	Qg				-	31	47	
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 12 A, V _{DS} = 480 V		-	12	-	nC	
Gate-drain charge	Q _{gd}				-	11	-	
Turn-on delay time	t _{d(on)}	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 12 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	19	38	- ns	
Rise time	t _r			-	33	66		
Turn-off delay time	t _{d(off)}			-	33	66		
Fall time	t _f			-	20	40		
Gate input resistance	Rg	f = 1 MHz, open drain		0.3	0.65	1.3	Ω	
Drain-Source Body Diode Characteristic	s							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	25	A	
Pulsed diode forward current	I _{SM}			-	-	66		
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 12 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	, , , , , , , , , , , , , , , , , , ,	~		-	117	234	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 12 \text{ A},$ di/dt = 100 A/µs, V _R = 400 V		-	0.7	1.4	μC	
Reverse recovery current	I _{RRM}			-	11	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

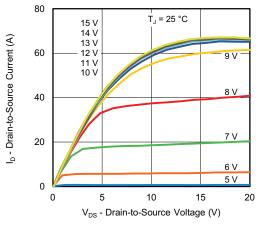


Fig. 1 - Typical Output Characteristics

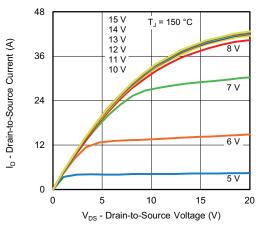


Fig. 2 - Typical Output Characteristics

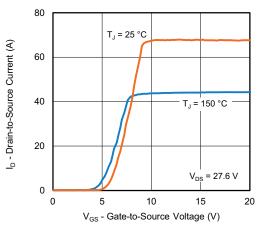


Fig. 3 - Typical Transfer Characteristics

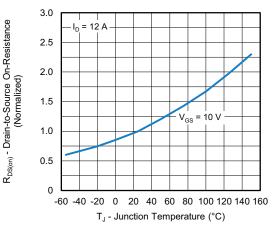


Fig. 4 - Normalized On-Resistance vs. Temperature

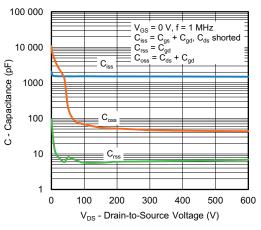


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

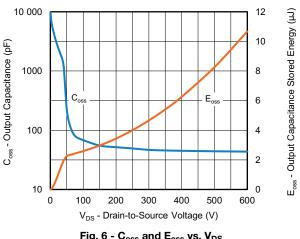


Fig. 6 - Coss and Eoss vs. VDS

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3 For technical questions, contact: hvm@vishay.com Document Number: 92271

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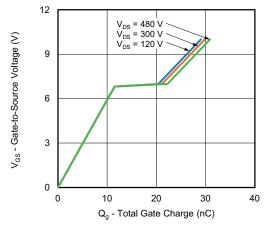


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

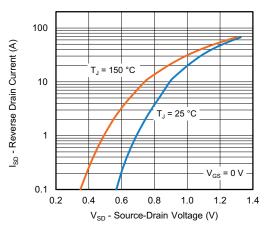


Fig. 8 - Typical Source-Drain Diode Forward Voltage

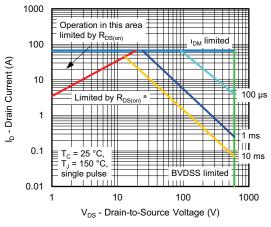


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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28 24 20 l_D - Drain Current (A) 16 12 8 4 0 25 50 75 100 125 150 T_C - Case Temperature (°C)

Fig. 10 - Maximum Drain Current vs. Case Temperature

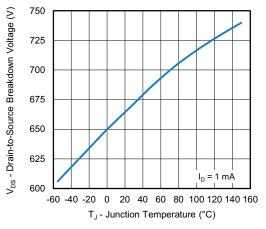


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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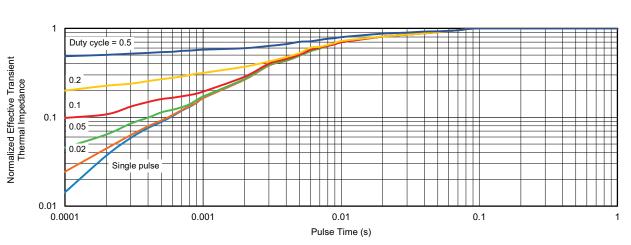
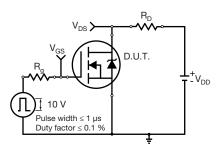


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case



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Fig. 13 - Switching Time Test Circuit

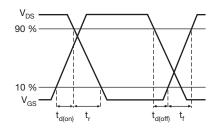


Fig. 14 - Switching Time Waveforms

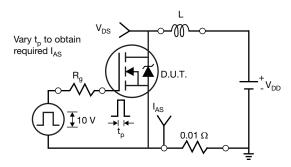


Fig. 15 - Unclamped Inductive Test Circuit

Fig. 16 - Unclamped Inductive Waveforms

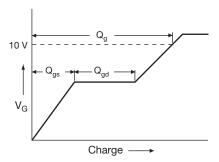


Fig. 17 - Basic Gate Charge Waveform

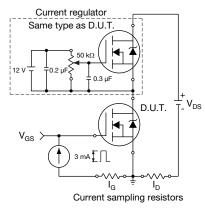


Fig. 18 - Gate Charge Test Circuit

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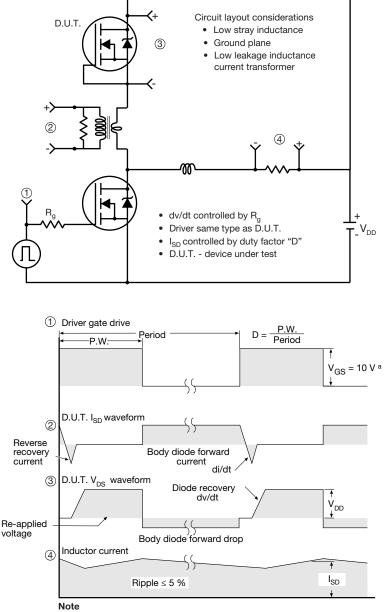
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SiHP125N60EF

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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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